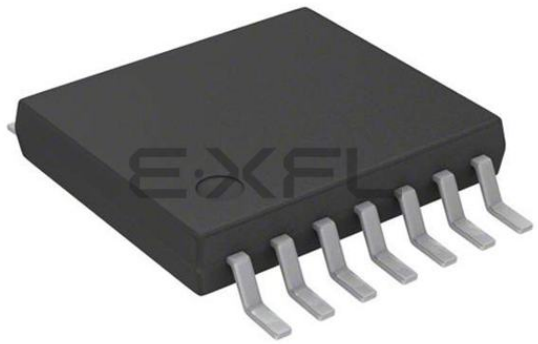

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	LINbus, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	12
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 8x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	14-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	14-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf1575-i-st

Analog Peripherals

- 10-Bit Analog-to-Digital Converter (ADC):
  - Up to 12 external channels
  - Conversion available during Sleep
- Two Comparators:
  - Low-Power/High-Speed modes
  - Fixed Voltage Reference at (non)inverting input(s)
  - Comparator outputs externally accessible
  - Synchronization with Timer1 clock source
  - Software hysteresis enable
- 5-Bit Digital-to-Analog Converter (DAC):
  - 5-bit resolution, rail-to-rail
  - Positive Reference Selection
  - Unbuffered I/O pin output
  - Internal connections to ADCs and comparators
- Voltage Reference:
  - Fixed Voltage Reference with 1.024V, 2.048V and 4.096V output levels

Clocking Structure

- Precision Internal Oscillator:
  - Factory calibrated ±1%, typical
  - Software-selectable clock speeds from 31 kHz to 32 MHz
- External Oscillator Block with:
  - Two external clock modes up to 32 MHz
- Digital Oscillator Input Available

TABLE 1: PIC12(L)F1571/2 AND PIC16(L)F1574/5/8/9 FAMILY TYPES

Device	Data Sheet Index	Program Flash Memory (Kwords)	Program Flash Memory (Kbytes)	Data SRAM (bytes)	I/O Pins	8-Bit/16-Bit Timers	Comparators	16-Bit PWM	10-Bit ADC (ch)	5-Bit DAC	CWG	EUSART	PPS	Debug(1)
PIC12(L)F1571	**(A)**	1	1.75	128	6	2/4**(2)**	1	3	4	1	1	0	N	I
PIC12(L)F1572	**(A)**	2	3.5	256	6	2/4**(2)**	1	3	4	1	1	1	N	I
PIC16(L)F1574	**(B)**	4	7	512	12	2/5**(3)**	2	4	8	1	1	1	Y	I
PIC16(L)F1575	**(B)**	8	14	1024	12	2/5**(3)**	2	4	8	1	1	1	Y	I
PIC16(L)F1578	**(B)**	4	7	512	18	2/5**(3)**	2	4	12	1	1	1	Y	I
PIC16(L)F1579	**(B)**	8	14	1024	18	2/5**(3)**	2	4	12	1	1	1	Y	I

Note 1: I – Debugging integrated on chip.

2: Three additional 16-bit timers available when not using the 16-bit PWM outputs.

3: Four additional 16-bit timers available when not using the 16-bit PWM outputs.

Data Sheet Index:

A) DS-40001723 PIC12(L)F1571/2 Data Sheet, 8-Pin Flash, 8-bit MCU with High-Precision 16-bit PWM

B) Future Release PIC16(L)F1574/5/8/9 Data Sheet, 8-Pin Flash, 8-bit MCU with High-Precision 16-bit PWM

Note: For other small form-factor package availability and marking information, please visit **http://www.microchip.com/packaging** or contact your local sales office.

TABLE 1-2: PIC16(L)F1574/5 PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0/AN0/C1IN+/DAC1OUT1/ ICSPDAT	RA0	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN0	AN	—	ADC Channel input.
	C1IN+	AN	—	Comparator positive input.
	DAC1OUT1	—	AN	Digital-to-Analog Converter output.
	ICSPDAT	ST	CMOS	ICSP™ Data I/O.
RA1/AN1/VREF+/C1IN0-/C2IN0-/ ICSPCLK	RA1	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN1	AN	—	ADC Channel input.
	VREF+	AN	—	Voltage Reference input.
	C1IN0-	AN	—	Comparator negative input.
	C2IN0-	AN	—	Comparator negative input.
	ICSPCLK	ST	—	ICSP Programming Clock.
RA2/AN2/T0CKI(1)/CWG1IN(1)/ INT(1)	RA2	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN2	AN	—	ADC Channel input.
	T0CKI	TTL/ST	—	Timer0 clock input.
	CWG1IN	TTL/ST	—	CWG complementary input.
	INT	TTL/ST	—	External interrupt.
RA3/VPP/$\overline{\text{MCLR}}$	RA3	TTL/ST	—	General purpose input with IOC and WPU.
	VPP	HV	—	Programming voltage.
	$\overline{\text{MCLR}}$	ST	—	Master Clear with internal pull-up.
RA4/AN3/T1G(1)/CLKOUT	RA4	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN3	AN	—	ADC Channel input.
	T1G	TTL/ST	—	Timer1 Gate input.
	CLKOUT	CMOS/OD	CMOS	FOSC/4 output.
RA5/CLKIN/T1CKI(1)	RA5	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	CLKIN	CMOS	—	External clock input (EC mode).
	T1CKI	TTL/ST	—	Timer1 clock input.
RC0/AN4/C2IN+	RC0	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN4	AN	—	ADC Channel input.
	C2IN+	AN	—	Comparator positive input.
RC1/AN5/C1IN1-/C2IN1-	RC1	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN5	AN	—	ADC Channel input.
	C1IN1-	AN	—	Comparator negative input.
	C2IN1-	AN	—	Comparator negative input.
RC2/AN6/C1IN2-/C2IN2-	RC2	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN6	AN	—	ADC Channel input.
	C1IN2-	AN	—	Comparator negative input.
	C2IN2-	AN	—	Comparator negative input.
RC3/AN7/C1IN3-/C2IN3-	RC3	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN7	AN	—	ADC Channel input.
	C1IN3-	AN	—	Comparator negative input.
	C2IN3-	AN	—	Comparator negative input.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open-Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I^2C = Schmitt Trigger input with I^2C levels
HV = High Voltage XTAL = Crystal

Note 1: Default peripheral input. Input can be moved to any other pin with the PPS input selection registers.

2: All pin outputs default to PORT latch data. Any pin can be selected as a digital peripheral output with the PPS output selection registers. See Register 12-1.

3: These USART functions are bidirectional. The output pin selections must be the same as the input pin selections.

TABLE 1-3: PIC16(L)F1578/9 PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0/AN0/C1IN+/DAC1OUT/ ICSPDAT	RA0	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN0	AN	—	ADC Channel input.
	C1IN+	AN	—	Comparator positive input.
	DAC1OUT	—	AN	Digital-to-Analog Converter output.
	ICSPDAT	ST	CMOS	ICSP™ Data I/O.
RA1/AN1/VREF+/C1IN0-/C2IN0-/ ICSPCLK	RA1	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN1	AN	—	ADC Channel input.
	VREF+	AN	—	Voltage Reference input.
	C1IN0-	AN	—	Comparator negative input.
	C2IN0-	AN	—	Comparator negative input.
	ICSPCLK	ST	—	ICSP Programming Clock.
RA2/AN2/T0CKI(1)/CWG1IN(1)/ INT(1)	RA2	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN2	AN	—	ADC Channel input.
	T0CKI	TTL/ST	—	Timer0 clock input.
	CWG1IN	TTL/ST	—	CWG complementary input.
	INT	TTL/ST	—	External interrupt.
RA3/VPP/$\overline{\text{MCLR}}$	RA3	TTL/ST	—	General purpose input with IOC and WPU.
	VPP	HV	—	Programming voltage.
	$\overline{\text{MCLR}}$	ST	—	Master Clear with internal pull-up.
RA4/AN3/T1G(1)/CLKOUT	RA4	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN3	AN	—	ADC Channel input.
	T1G	TTL/ST	—	Timer1 Gate input.
	CLKOUT	—	CMOS	FOSC/4 output.
RA5/CLKIN/T1CKI(1)	RA5	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	CLKIN	CMOS	—	External clock input (EC mode).
	T1CKI	TTL/ST	—	Timer1 clock input.
RB4/AN10	RB4	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN10	AN	—	ADC Channel input.
RB5/AN11/RX(1)	RB5	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN11	AN	—	ADC Channel input.
	RX	ST	—	USART asynchronous input.
RB6	RB6	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
RB7/CK	RB7	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	CK	ST	CMOS	USART synchronous clock.
RC0/AN4/C2IN+	RC0	TTL/ST	CMOS/OD	General purpose input with IOC and WPU.
	AN4	AN	—	ADC Channel input.
	C2IN+	AN	—	Comparator positive input.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open-Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I^2C = Schmitt Trigger input with I^2C levels
HV = High Voltage XTAL = Crystal

Note 1: Default peripheral input. Input can be moved to any other pin with the PPS input selection registers.

2: All pin outputs default to PORT latch data. Any pin can be selected as a digital peripheral output with the PPS output selection registers. See Register 12-1.

3: These USART functions are bidirectional. The output pin selections must be the same as the input pin selections.

3.5 Stack

All devices have a 16-level x 15-bit wide hardware stack (refer to Figures 3-5 through 3-8). The stack space is not part of either program or data space. The PC is PUSHed onto the stack when CALL or CALLW instructions are executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a PUSH or POP operation.

The stack operates as a circular buffer if the STVREN bit is programmed to '0' (Configuration Words). This means that after the stack has been PUSHed sixteen times, the seventeenth PUSH overwrites the value that was stored from the first PUSH. The eighteenth PUSH overwrites the second PUSH (and so on). The STKOVF and STKUNF flag bits will be set on an Overflow/Underflow, regardless of whether the Reset is enabled.

Note 1: There are no instructions/mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, CALLW, RETURN, RETLW and RETFIE instructions or the vectoring to an interrupt address.

3.5.1 ACCESSING THE STACK

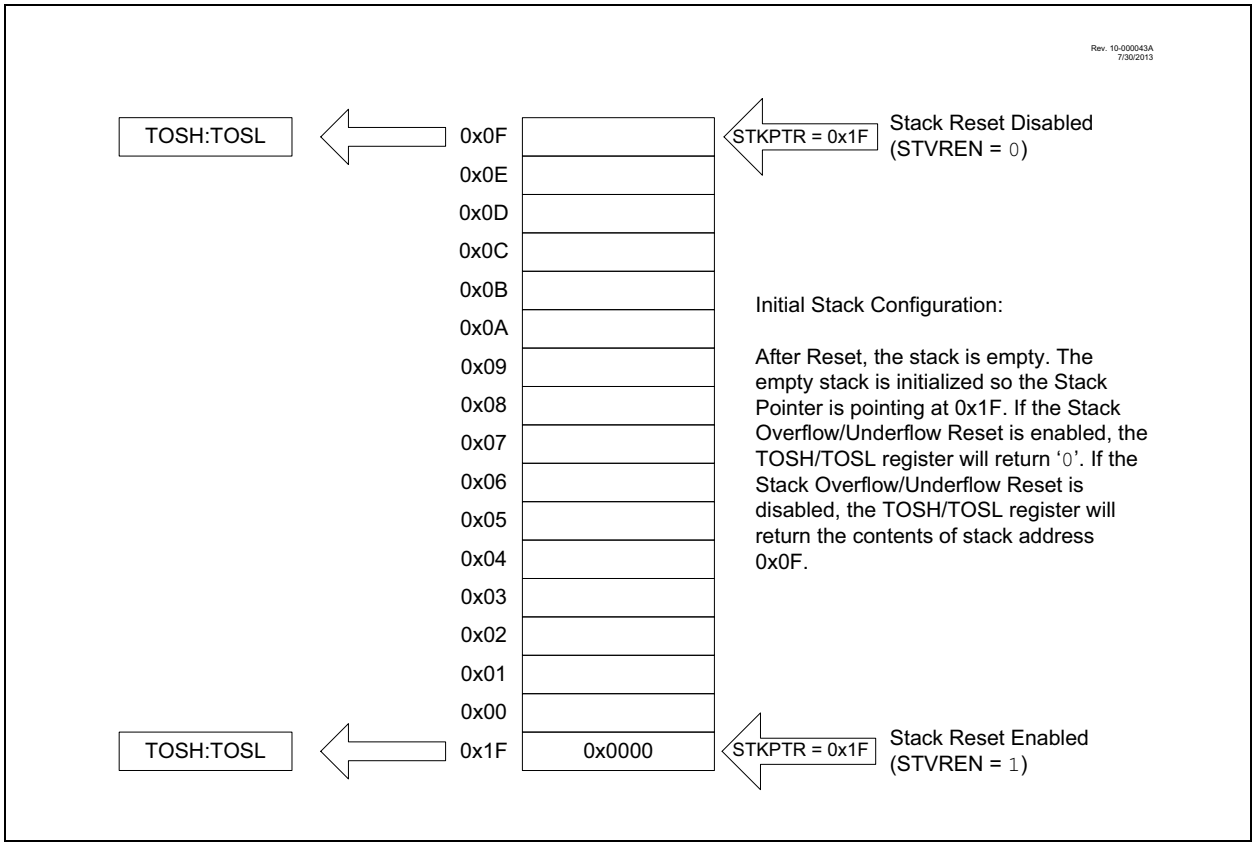
The stack is available through the TOSH, TOSL and STKPTR registers. STKPTR is the current value of the Stack Pointer. TOSH:TOSL register pair points to the TOP of the stack. Both registers are read/writable. TOS is split into TOSH and TOSL due to the 15-bit size of the PC. To access the stack, adjust the value of STKPTR, which will position TOSH:TOSL, then read/write to TOSH:TOSL. STKPTR is five bits to allow detection of overflow and underflow.

Note: Care should be taken when modifying the STKPTR while interrupts are enabled.

During normal program operation, CALL, CALLW and Interrupts will increment STKPTR while RETLW, RETURN, and RETFIE will decrement STKPTR. At any time STKPTR can be inspected to see how much stack is left. The STKPTR always points at the currently used place on the stack. Therefore, a CALL or CALLW will increment the STKPTR and then write the PC, and a return will unload the PC and then decrement the STKPTR.

Reference Figure 3-5 through Figure 3-8 for examples of accessing the stack.

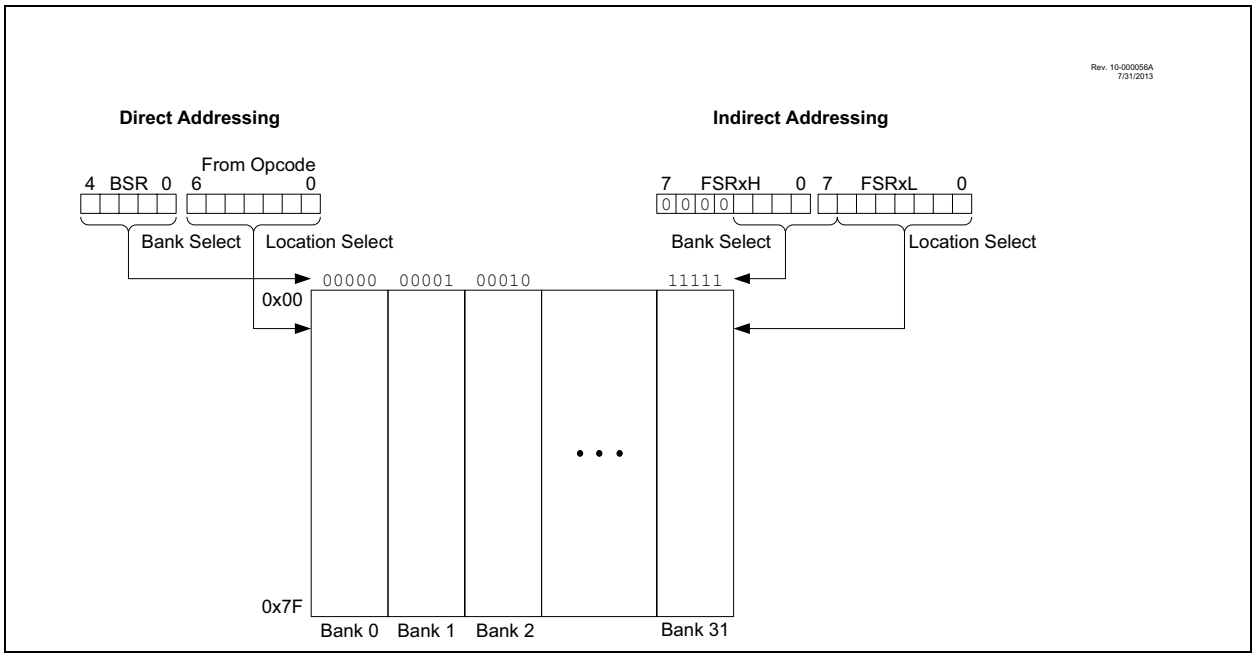
FIGURE 3-5: ACCESSING THE STACK EXAMPLE 1



3.6.1 TRADITIONAL DATA MEMORY

The traditional data memory is a region from FSR address 0x000 to FSR address 0xFFF. The addresses correspond to the absolute addresses of all SFR, GPR and common registers.

FIGURE 3-10: TRADITIONAL DATA MEMORY MAP



REGISTER 4-2: CONFIGURATION WORD 2 (CONTINUED)

bit 1-0 **WRT<1:0>:** Flash Memory Self-Write Protection bits

4 kW Flash memory: (PIC16(L)F1574/8):

11 =	OFF	Write protection off
10 =	BOOT	0000h to 1FFh write protected, 0200h to 0FFFh may be modified by PMCON control
01 =	HALF	0000h to 07FFh write protected, 0800h to 0FFFh may be modified by PMCON control
00 =	ALL	0000h to 0FFFh write protected, no addresses may be modified by PMCON control

8 kW Flash memory: (PIC16(L)F1575/9)

11 =	OFF	Write protection off
10 =	BOOT	0000h to 1FFh write protected, 0200h to 1FFFh may be modified by PMCON control
01 =	HALF	0000h to 0FFFh write protected, 1000h to 1FFFh may be modified by PMCON control
00 =	ALL	0000h to 1FFFh write protected, no addresses may be modified by PMCON control

Note 1: This bit cannot be programmed to '0' when programming mode is entered via LVP.

2: The $\overline{\text{DEBUG}}$ bit in Configuration Words is managed automatically by device development tools including debuggers and programmers. For normal device operation, this bit should be maintained as a '1'.

3: See V_{BOR} parameter for specific trip point voltages.

5.2.2 INTERNAL CLOCK SOURCES

The device may be configured to use the internal oscillator block as the system clock by performing one of the following actions:

- Program the FOSC<1:0> bits in Configuration Words to select the INTOSC clock source, which will be used as the default system clock upon a device Reset.
- Write the SCS<1:0> bits in the OSCCON register to switch the system clock source to the internal oscillator during run-time. See **Section 5.3 "Clock Switching"**for more information.

In **INTOSC** mode, CLKIN is available for general purpose I/O. CLKOUT is available for general purpose I/O or CLKOUT.

The function of the OSC2/CLKOUT pin is determined by the CLKOUTEN bit in Configuration Words.

The internal oscillator block has two independent oscillators and a dedicated Phase Lock Loop, HFPLL that can produce one of three internal system clock sources.

1. The **HFINTOSC** (High-Frequency Internal Oscillator) is factory calibrated and operates at 16 MHz. The HFINTOSC source is generated from the 500 kHz MFINTOSC source and the dedicated Phase Lock Loop, HFPLL. The frequency of the HFINTOSC can be user-adjusted via software using the OSCTUNE register (Register 5-3).
2. The **MFINTOSC** (Medium-Frequency Internal Oscillator) is factory calibrated and operates at 500 kHz. The frequency of the MFINTOSC can be user-adjusted via software using the OSCTUNE register (Register 5-3).
3. The **LFINTOSC** (Low-Frequency Internal Oscillator) is uncalibrated and operates at 31 kHz.

5.2.2.1 HFINTOSC

The High-Frequency Internal Oscillator (HFINTOSC) is a factory calibrated 16 MHz internal clock source. The frequency of the HFINTOSC can be altered via software using the OSCTUNE register (Register 5-3).

The output of the HFINTOSC connects to a postscaler and multiplexer (see Figure 5-1). One of multiple frequencies derived from the HFINTOSC can be selected via software using the IRCF<3:0> bits of the OSCCON register. See **Section 5.2.2.8 "Internal Oscillator Clock Switch Timing"** for more information.

The HFINTOSC is enabled by:

- Configure the IRCF<3:0> bits of the OSCCON register for the desired HF frequency, and
- FOSC<1:0> = 00, or
- Set the System Clock Source (SCS) bits of the OSCCON register to '1x'.

A fast start-up oscillator allows internal circuits to power up and stabilize before switching to HFINTOSC.

The High-Frequency Internal Oscillator Ready bit (HFIOFR) of the OSCSTAT register indicates when the HFINTOSC is running.

The High-Frequency Internal Oscillator Status Locked bit (HFIOFL) of the OSCSTAT register indicates when the HFINTOSC is running within 2% of its final value.

The High-Frequency Internal Oscillator Stable bit (HFIOFS) of the OSCSTAT register indicates when the HFINTOSC is running within 0.5% of its final value.

5.2.2.2 MFINTOSC

The Medium-Frequency Internal Oscillator (MFINTOSC) is a factory calibrated 500 kHz internal clock source. The frequency of the MFINTOSC can be altered via software using the OSCTUNE register (Register 5-3).

The output of the MFINTOSC connects to a postscaler and multiplexer (see Figure 5-1). One of nine frequencies derived from the MFINTOSC can be selected via software using the IRCF<3:0> bits of the OSCCON register. See **Section 5.2.2.8 "Internal Oscillator Clock Switch Timing"** for more information.

The MFINTOSC is enabled by:

- Configure the IRCF<3:0> bits of the OSCCON register for the desired HF frequency, and
- FOSC<1:0> = 00, or
- Set the System Clock Source (SCS) bits of the OSCCON register to '1x'

The Medium-Frequency Internal Oscillator Ready bit (MFIOFR) of the OSCSTAT register indicates when the MFINTOSC is running.

TABLE 5-2: SUMMARY OF REGISTERS ASSOCIATED WITH CLOCK SOURCES

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
OSCCON	SPLLEN	IRCF<3:0>				—	SCS<1:0>		69
OSCSTAT	—	PLLR	OSTS	HFIOFR	HFIOFL	MFIOFR	LFIOFR	HFIOFS	70
OSCTUNE	—	—	TUN<5:0>						71

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

TABLE 5-3: SUMMARY OF CONFIGURATION WORD WITH CLOCK SOURCES

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
CONFIG1	13:8	—	—	—	—	$\overline{\text{CLKOUTEN}}$	BOREN<1:0>		—	56
	7:0	$\overline{\text{CP}}$	MCLRE	$\overline{\text{PWRTE}}$	WDTE<1:0>		—	FOSC<1:0>		

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

7.0 INTERRUPTS

The interrupt feature allows certain events to preempt normal program flow. Firmware is used to determine the source of the interrupt and act accordingly. Some interrupts can be configured to wake the MCU from Sleep mode.

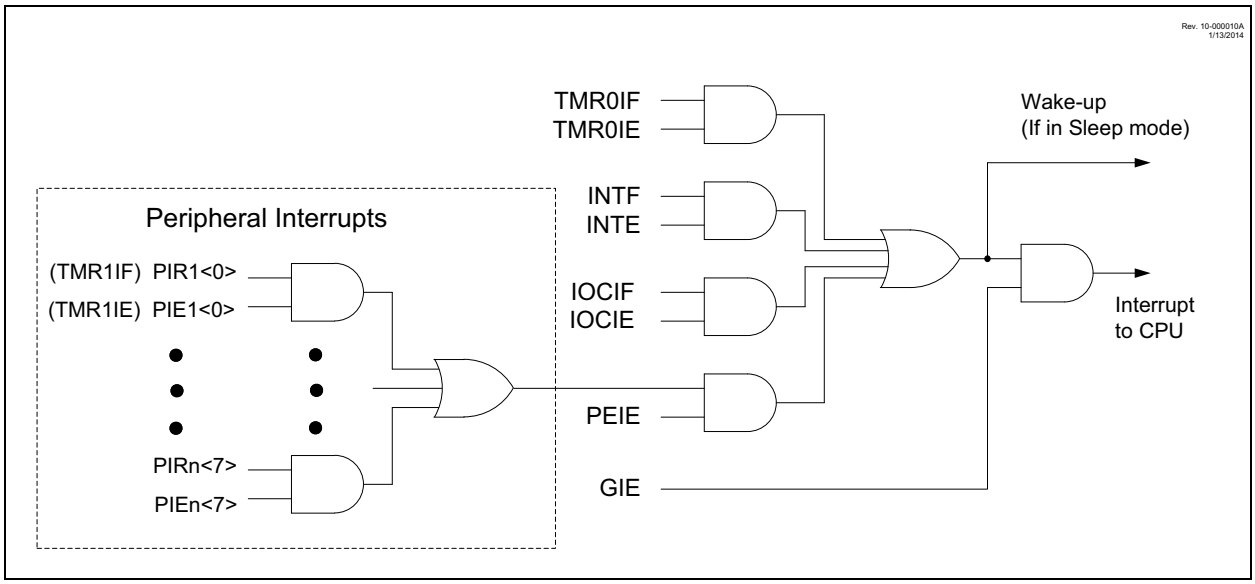
This chapter contains the following information for Interrupts:

- Operation
- Interrupt Latency
- Interrupts During Sleep
- INT Pin
- Automatic Context Saving

Many peripherals produce interrupts. Refer to the corresponding chapters for details.

A block diagram of the interrupt logic is shown in Figure 7-1.

FIGURE 7-1: INTERRUPT LOGIC

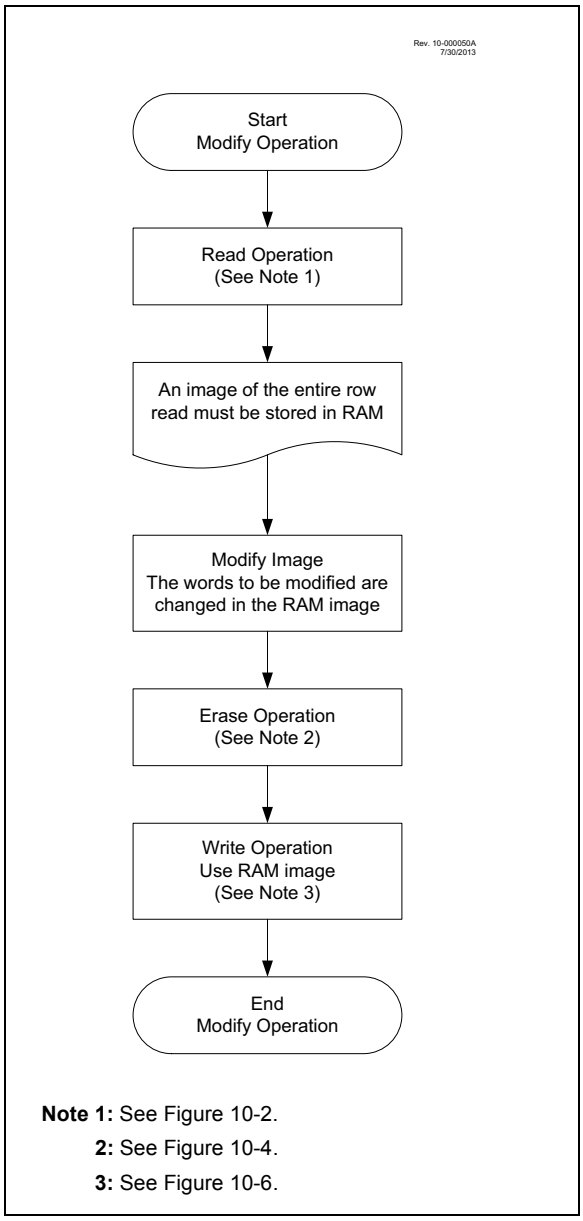


10.3 Modifying Flash Program Memory

When modifying existing data in a program memory row, and data within that row must be preserved, it must first be read and saved in a RAM image. Program memory is modified using the following steps:

1. Load the starting address of the row to be modified.
2. Read the existing data from the row into a RAM image.
3. Modify the RAM image to contain the new data to be written into program memory.
4. Load the starting address of the row to be rewritten.
5. Erase the program memory row.
6. Load the write latches with data from the RAM image.
7. Initiate a programming operation.

FIGURE 10-7: FLASH PROGRAM MEMORY MODIFY FLOWCHART



Note 1: See Figure 10-2.
2: See Figure 10-4.
3: See Figure 10-6.

11.3 PORTB Registers (PIC16(L)F1578/9 only)

PORTB is a 4-bit wide, bidirectional port. The corresponding data direction register is TRISB (Register 11-10). Setting a TRISB bit (= 1) will make the corresponding PORTB pin an input (i.e., put the corresponding output driver in a High-Impedance mode). Clearing a TRISB bit (= 0) will make the corresponding PORTB pin an output (i.e., enable the output driver and put the contents of the output latch on the selected pin). Example 11-1 shows how to initialize an I/O port.

Reading the PORTB register (Register 11-9) reads the status of the pins, whereas writing to it will write to the PORT latch. All write operations are read-modify-write operations. Therefore, a write to a port implies that the port pins are read, this value is modified and then written to the PORT data latch (LATB).

11.3.1 DIRECTION CONTROL

The TRISB register (Register 11-10) controls the PORTB pin output drivers, even when they are being used as analog inputs. The user should ensure the bits in the TRISB register are maintained set when using them as analog inputs. I/O pins configured as analog inputs always read '0'.

11.3.2 OPEN-DRAIN CONTROL

The ODCONB register (Register 11-14) controls the open-drain feature of the port. Open-drain operation is independently selected for each pin. When an ODCONB bit is set, the corresponding port output becomes an open-drain driver capable of sinking current only. When an ODCONB bit is cleared, the corresponding port output pin is the standard push-pull drive capable of sourcing and sinking current.

11.3.3 SLEW RATE CONTROL

The SLRCONB register (Register 11-15) controls the slew rate option for each port pin. Slew rate control is independently selectable for each port pin. When an SLRCONB bit is set, the corresponding port pin drive is slew rate limited. When an SLRCONB bit is cleared, The corresponding port pin drive slews at the maximum rate possible.

11.3.4 INPUT THRESHOLD CONTROL

The INLVLB register (Register 11-16) controls the input voltage threshold for each of the available PORTB input pins. A selection between the Schmitt Trigger CMOS or the TTL Compatible thresholds is available. The input threshold is important in determining the value of a read of the PORTB register and also the level at which an interrupt-on-change occurs, if that feature is enabled. See Table 27-4 for more information on threshold levels.

Note:	Changing the input threshold selection should be performed while all peripheral modules are disabled. Changing the threshold level during the time a module is active may inadvertently generate a transition associated with an input pin, regardless of the actual voltage level on that pin.

11.3.5 ANALOG CONTROL

The ANSELB register (Register 11-12) is used to configure the Input mode of an I/O pin to analog. Setting the appropriate ANSELB bit high will cause all digital reads on the pin to be read as '0' and allow analog functions on the pin to operate correctly.

The state of the ANSELB bits has no effect on digital output functions. A pin with TRIS clear and ANSELB set will still operate as a digital output, but the Input mode will be analog. This can cause unexpected behavior when executing read-modify-write instructions on the affected port.

Note:	The ANSELB bits default to the Analog mode after Reset. To use any pins as digital general purpose or peripheral inputs, the corresponding ANSEL bits must be initialized to '0' by user software.

11.3.6 PORTB FUNCTIONS AND OUTPUT PRIORITIES

Each pin defaults to the PORT latch data after Reset. Other functions are selected with the peripheral pin select logic. See **Section 12.0 "Peripheral Pin Select (PPS) Module"** for more information. Analog input functions, such as ADC and op amp inputs, are not shown in the peripheral pin select lists. These inputs are active when the I/O pin is set for Analog mode using the ANSELB register. Digital output functions may continue to control the pin when it is in Analog mode.

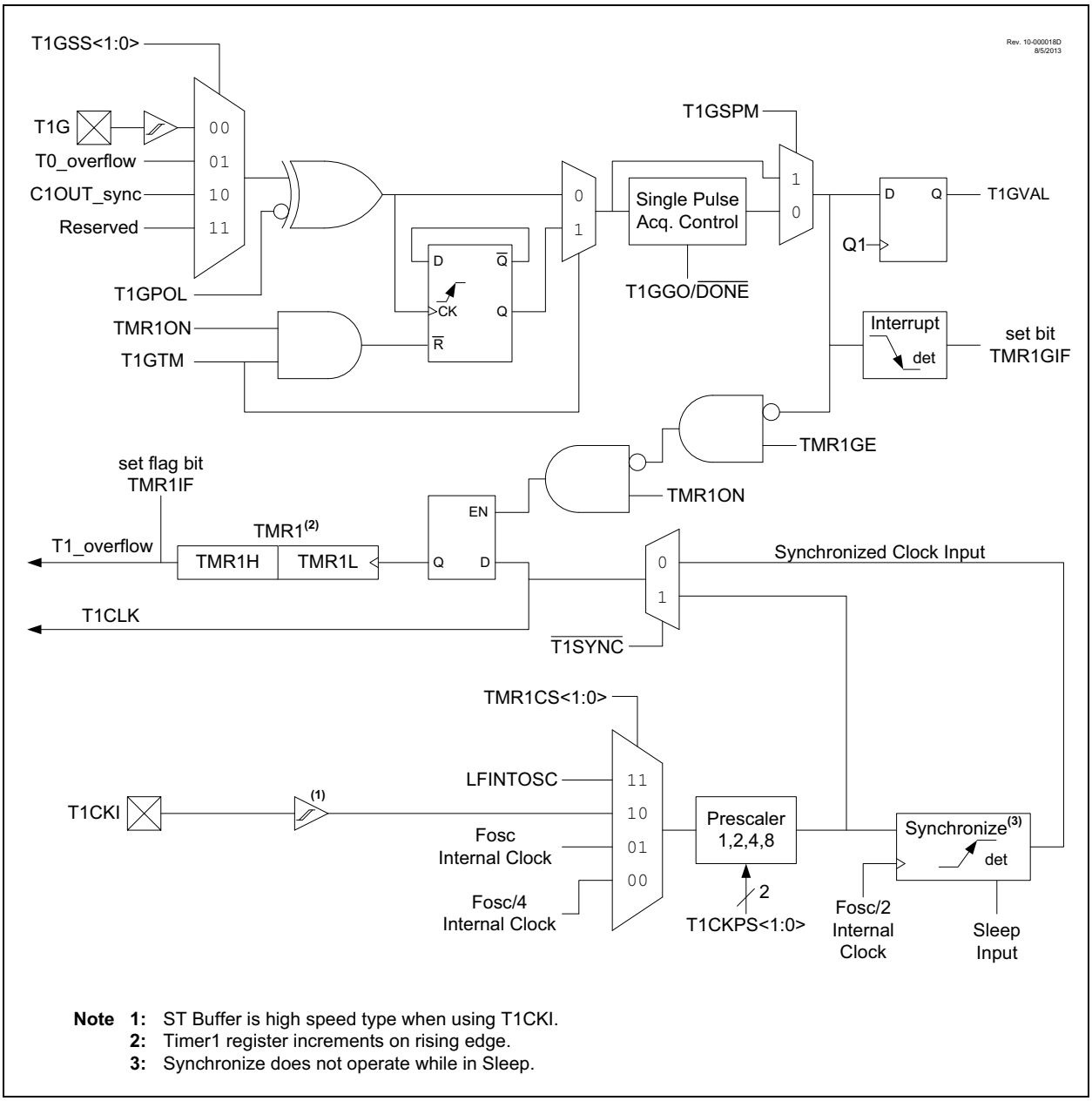
20.0 TIMER1 MODULE WITH GATE CONTROL

The Timer1 module is a 16-bit timer/counter with the following features:

- 16-bit timer/counter register pair (TMR1H:TMR1L)
- Programmable internal or external clock source
- 2-bit prescaler
- Optionally synchronized comparator out
- Multiple Timer1 gate (count enable) sources
- Interrupt on overflow
- Wake-up on overflow (external clock, Asynchronous mode only)
- ADC Auto-Conversion Trigger(s)
- Selectable Gate Source Polarity
- Gate Toggle mode
- Gate Single-Pulse mode
- Gate Value Status
- Gate Event Interrupt

Figure 20-1 is a block diagram of the Timer1 module.

FIGURE 20-1: TIMER1 BLOCK DIAGRAM



Note 1: ST Buffer is high speed type when using T1CKI.
2: Timer1 register increments on rising edge.
3: Synchronize does not operate while in Sleep.

TABLE 22-1: SUMMARY OF REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
BAUDCON	ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN	204
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	86
PIE1	TMR1GIE	ADIE	RCIE	TXIE	—	—	TMR2IE	TMR1IE	87
PIR1	TMR1GIF	ADIF	RCIF	TXIF	—	—	TMR2IF	TMR1IF	90
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	203*
SPBRGL	BRG<7:0>								205*
SPBRGH	BRG<15:8>								205*
TXREG	EUSART Transmit Data Register								194
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	202

Legend: — = unimplemented location, read as '0'. Shaded cells are not used for asynchronous transmission.

* Page provides register information.

22.1.2.8 Asynchronous Reception Set-up:

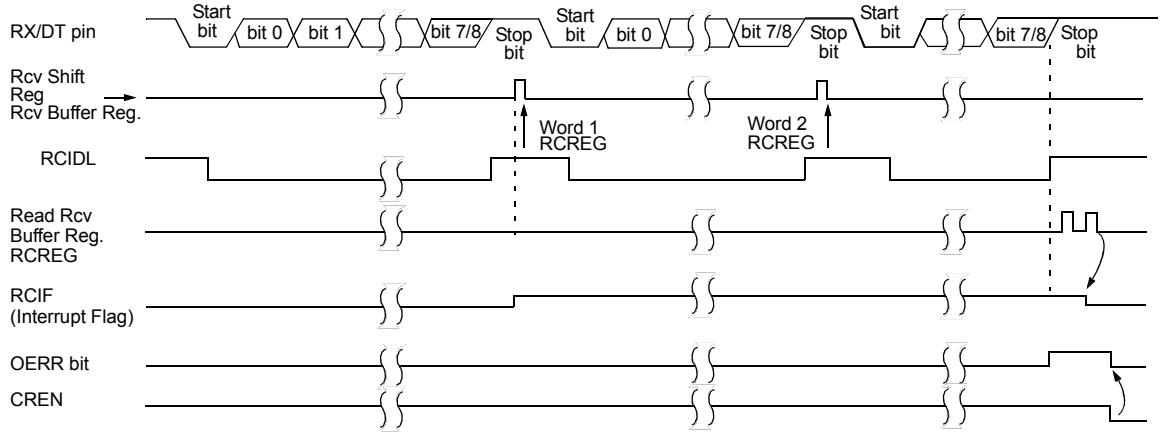
1. Initialize the SPBRGH, SPBRGL register pair and the BRGH and BRG16 bits to achieve the desired baud rate (see **Section 22.4 "EUSART Baud Rate Generator (BRG)"**).
2. Clear the ANSEL bit for the RX pin (if applicable).
3. Enable the serial port by setting the SPEN bit. The SYNC bit must be clear for asynchronous operation.
4. If interrupts are desired, set the RCIE bit of the PIE1 register and the GIE and PEIE bits of the INTCON register.
5. If 9-bit reception is desired, set the RX9 bit.
6. Enable reception by setting the CREN bit.
7. The RCIF interrupt flag bit will be set when a character is transferred from the RSR to the receive buffer. An interrupt will be generated if the RCIE interrupt enable bit was also set.
8. Read the RCSTA register to get the error flags and, if 9-bit data reception is enabled, the ninth data bit.
9. Get the received eight Least Significant data bits from the receive buffer by reading the RCREG register.
10. If an overrun occurred, clear the OERR flag by clearing the CREN receiver enable bit.

22.1.2.9 9-bit Address Detection Mode Set-up

This mode would typically be used in RS-485 systems. To set up an Asynchronous Reception with Address Detect Enable:

1. Initialize the SPBRGH, SPBRGL register pair and the BRGH and BRG16 bits to achieve the desired baud rate (see **Section 22.4 "EUSART Baud Rate Generator (BRG)"**).
2. Clear the ANSEL bit for the RX pin (if applicable).
3. Enable the serial port by setting the SPEN bit. The SYNC bit must be clear for asynchronous operation.
4. If interrupts are desired, set the RCIE bit of the PIE1 register and the GIE and PEIE bits of the INTCON register.
5. Enable 9-bit reception by setting the RX9 bit.
6. Enable address detection by setting the ADDEN bit.
7. Enable reception by setting the CREN bit.
8. The RCIF interrupt flag bit will be set when a character with the ninth bit set is transferred from the RSR to the receive buffer. An interrupt will be generated if the RCIE interrupt enable bit was also set.
9. Read the RCSTA register to get the error flags. The ninth data bit will always be set.
10. Get the received eight Least Significant data bits from the receive buffer by reading the RCREG register. Software determines if this is the device's address.
11. If an overrun occurred, clear the OERR flag by clearing the CREN receiver enable bit.
12. If the device has been addressed, clear the ADDEN bit to allow all received data into the receive buffer and generate interrupts.

FIGURE 22-5: ASYNCHRONOUS RECEPTION



Note: This timing diagram shows three words appearing on the RX input. The RCREG (receive buffer) is read after the third word, causing the OERR (overrun) bit to be set.

23.0 16-BIT PULSE-WIDTH MODULATION (PWM) MODULE

The Pulse-Width Modulation (PWM) module generates a pulse width modulated signal determined by the phase, duty cycle, period, and offset event counts that are contained in the following registers:

- PWMxPH register
- PWMxDC register
- PWMxPR register
- PWMxOF register

Figure 23-1 shows a simplified block diagram of the PWM operation.

Each PWM module has four modes of operation:

- Standard
- Set On Match
- Toggle On Match
- Center-Aligned

For a more detailed description of each PWM mode, refer to **Section 23.2 "PWM Modes"**.

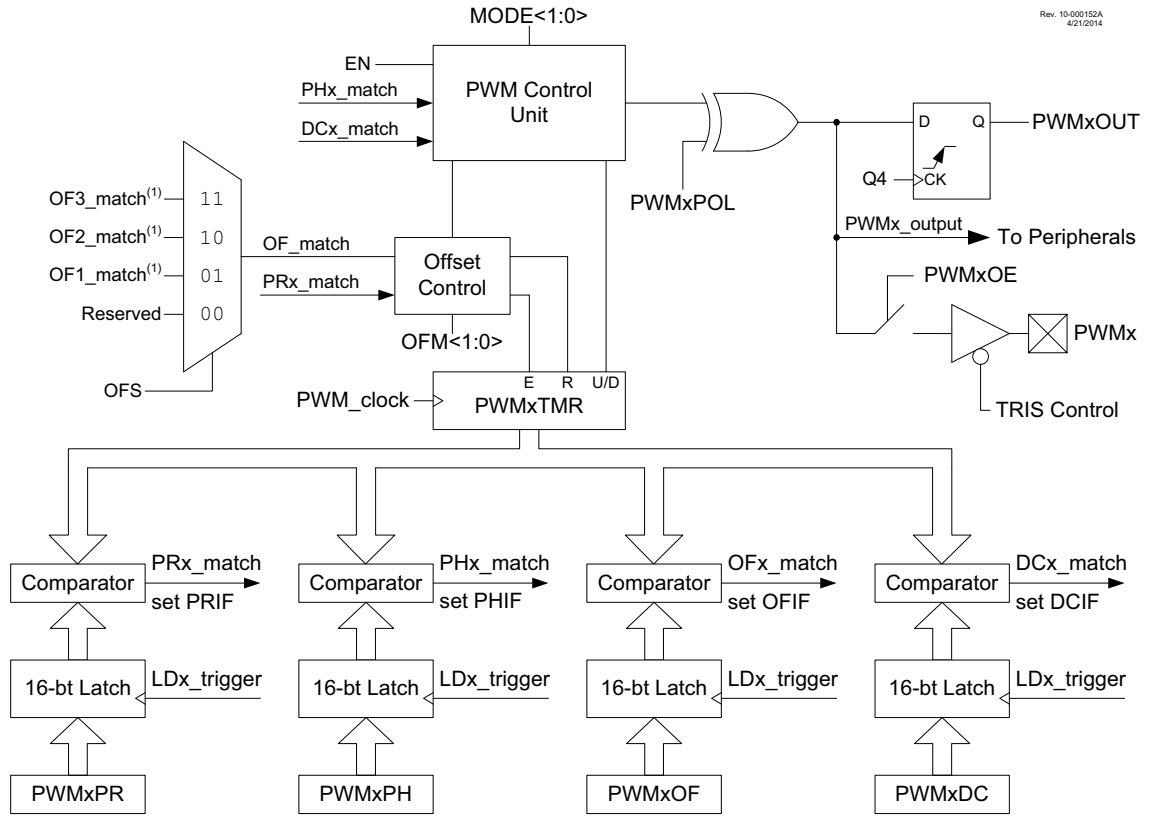
Each PWM module has four offset modes:

- Independent Run
- Slave Run with Synchronous Start
- One-Shot Slave with Synchronous Start
- Continuous Run Slave with Synchronous Start and Timer Reset

Using the offset modes, each PWM module can offset its waveform relative to any other PWM module in the same device. For a more detailed description of the offset modes refer to **Section 23.3 "Offset Modes"**.

Every PWM module has a configurable reload operation to ensure all event count buffers change at the end of a period thereby avoiding signal glitches. Figure 23-2 shows a simplified block diagram of the reload operation. For a more detailed description of the reload operation, refer to Section **Section 23.4 "Reload Operation"**.

FIGURE 23-1: 16-BIT PWM BLOCK DIAGRAM



Note 1: A PWM module cannot trigger from its own offset match event. The input corresponding to a PWM module's own offset match is reserved.

FIGURE 27-7: CLKOUT AND I/O TIMING

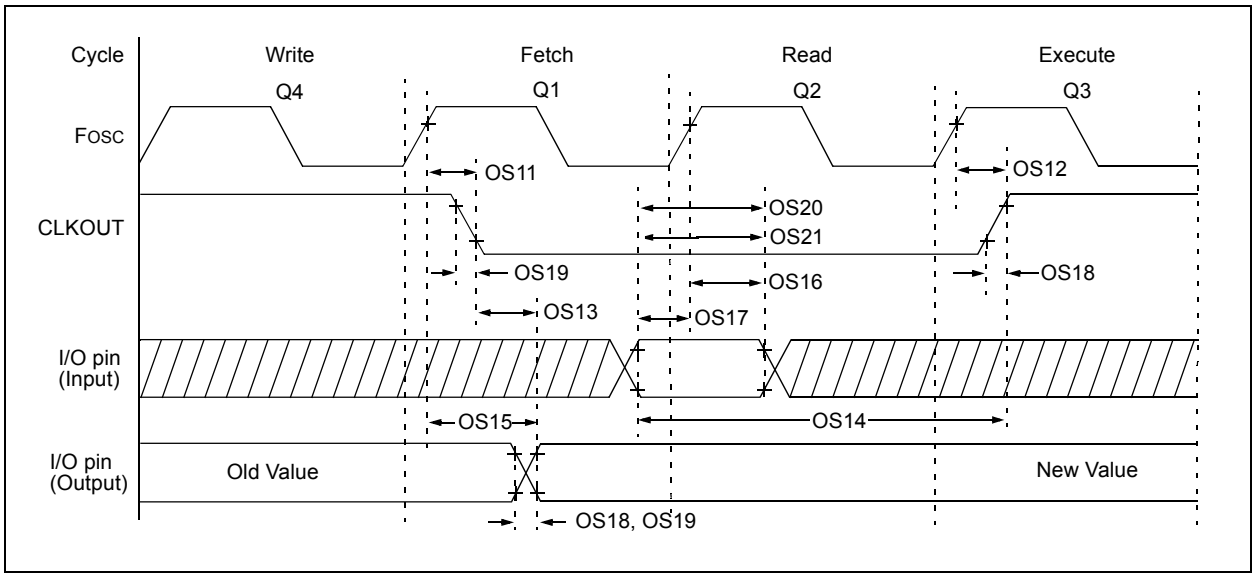


TABLE 27-10: CLKOUT AND I/O TIMING PARAMETERS

Standard Operating Conditions (unless otherwise stated)							
Param. No.	**Sym.**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
OS11	TosH2ckL	FOSC↑ to CLKOUT↓(1)	—	—	70	ns	3.3V ≤ VDD ≤ 5.0V
OS12	TosH2ckH	FOSC↑ to CLKOUT↑(1)	—	—	72	ns	3.3V ≤ VDD ≤ 5.0V
OS13	TckL2ioV	CLKOUT↓ to Port out valid(1)	—	—	20	ns	
OS14	TioV2ckH	Port input valid before CLKOUT↑(1)	TOSC + 200 ns	—	—	ns	
OS15	TosH2ioV	Fosc↑ (Q1 cycle) to Port out valid	—	50	70*	ns	3.3V ≤ VDD ≤ 5.0V
OS16	TosH2ioI	Fosc↑ (Q2 cycle) to Port input invalid (I/O in setup time)	50	—	—	ns	3.3V ≤ VDD ≤ 5.0V
OS17	TioV2osH	Port input valid to Fosc↑ (Q2 cycle) (I/O in setup time)	20	—	—	ns	
OS18*	TioR	Port output rise time	— —	40 15	72 32	ns	VDD = 1.8V 3.3V ≤ VDD ≤ 5.0V
OS19*	TioF	Port output fall time	— —	28 15	55 30	ns	VDD = 1.8V 3.3V ≤ VDD ≤ 5.0V
OS20*	Tinp	INT pin input high or low time	25	—	—	ns	
OS21*	Tioc	Interrupt-on-change new input level time	25	—	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated.

Note 1: Measurements are taken in EXTRC mode where CLKOUT output is 4 x TOSC.

FIGURE 27-11: ADC CONVERSION TIMING (ADC CLOCK Fosc-BASED)

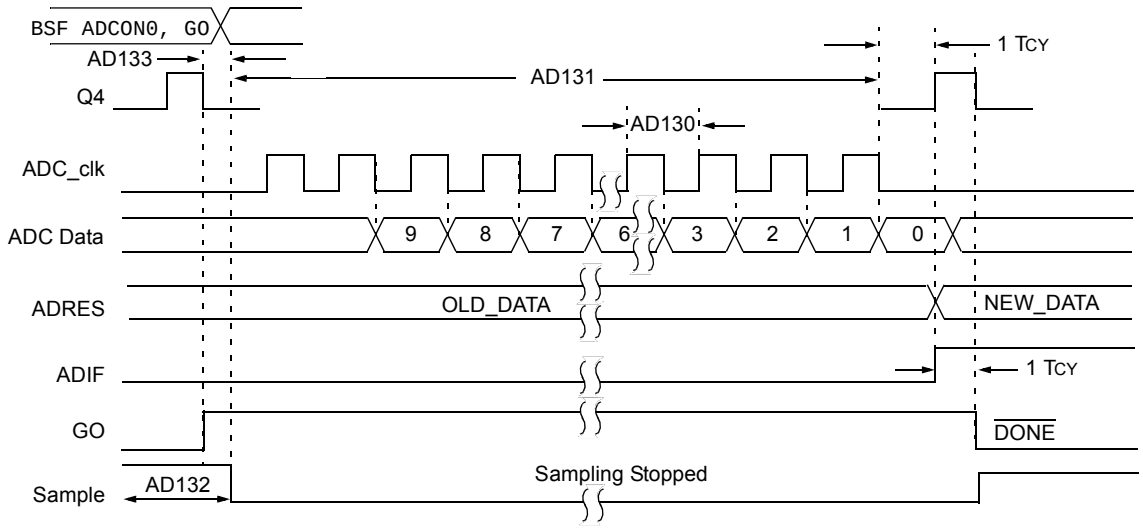
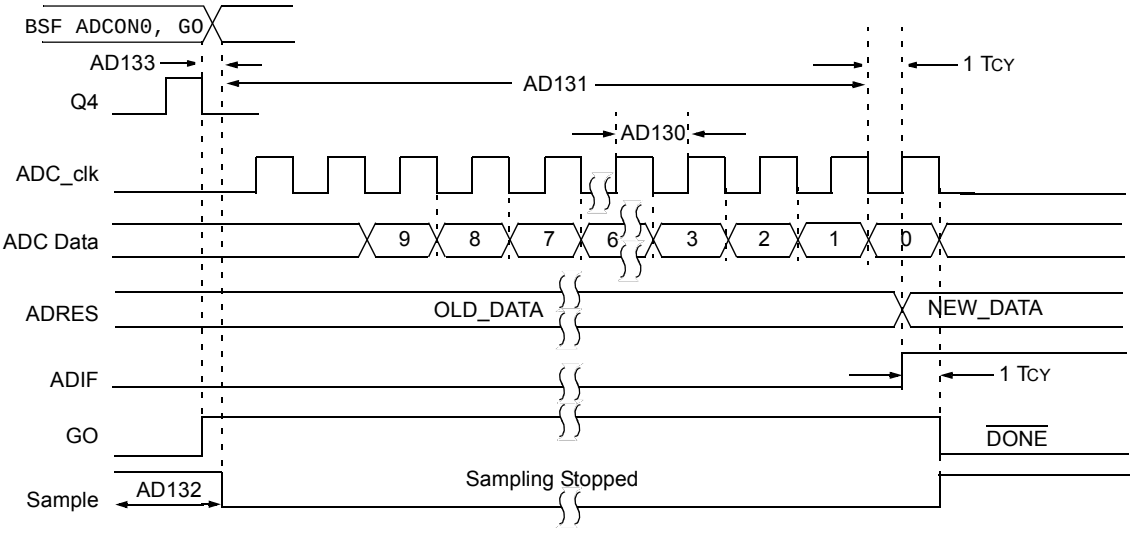


FIGURE 27-12: ADC CONVERSION TIMING (ADC CLOCK FROM FRC)



Note 1: If the ADC clock source is selected as FRC, a time of TCY is added before the ADC clock starts. This allows the SLEEP instruction to be executed.

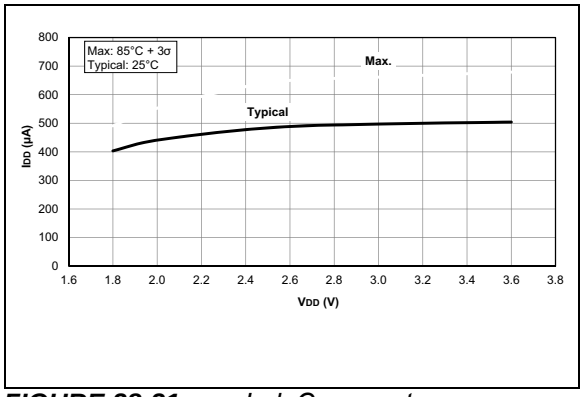


FIGURE 28-31: *Ipd, Comparator, Low-Power Mode (CxSP = 0), PIC16LF1574/5/8/9 Only.*

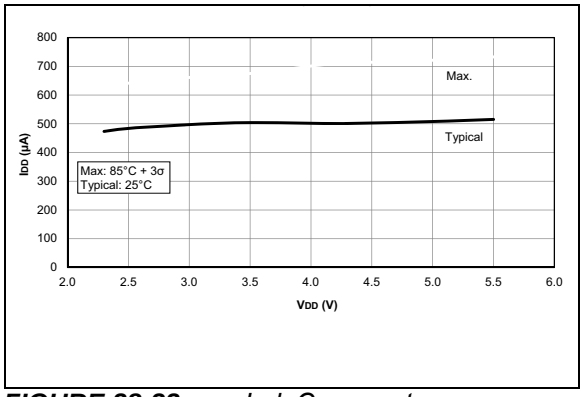


FIGURE 28-32: *Ipd, Comparator, Low-Power Mode (CxSP = 0), PIC16F1574/5/8/9 Only.*

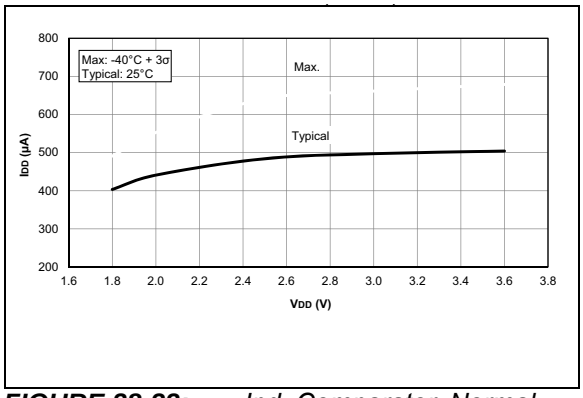


FIGURE 28-33: *Ipd, Comparator, Normal Power Mode (CxSP = 1), PIC16LF1574/5/8/9 Only.*

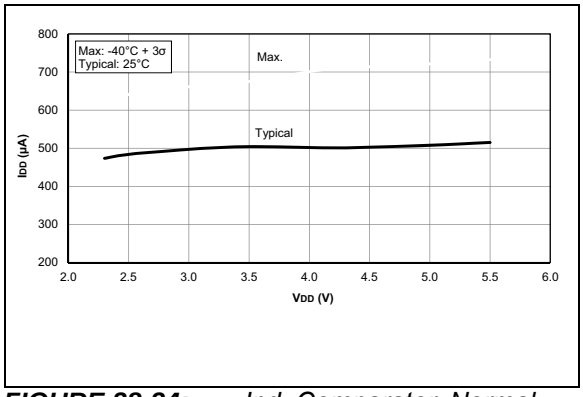


FIGURE 28-34: *Ipd, Comparator, Normal Power Mode (CxSP = 1), PIC16F1574/5/8/9 Only.*

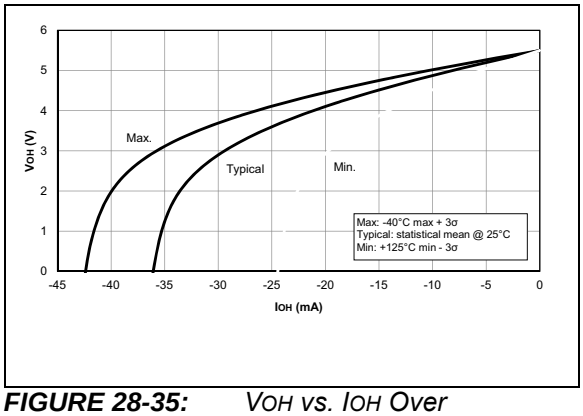


FIGURE 28-35: *VOH vs. IOH Over Temperature, VDD = 5.5V, PIC16F1574/5/8/9 Only.*

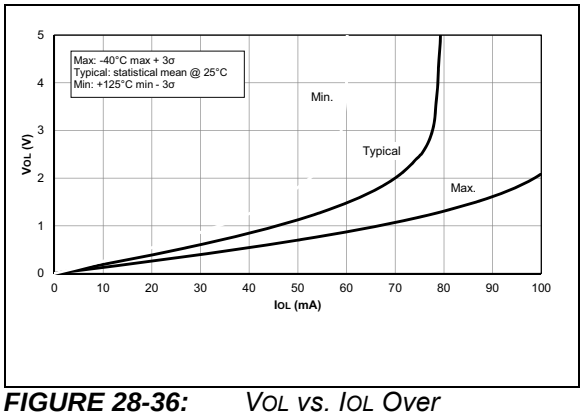


FIGURE 28-36: *VOL vs. IOL Over Temperature, VDD = 5.5V, PIC16F1574/5/8/9 Only.*

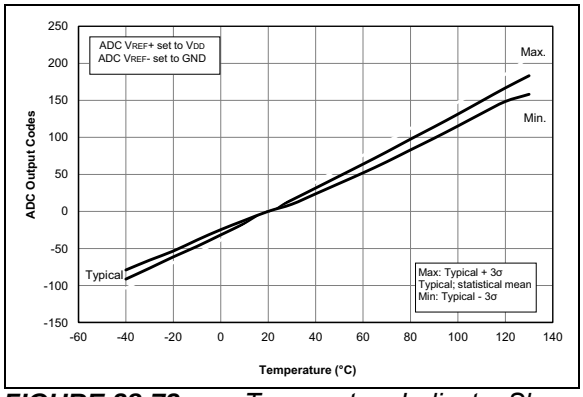
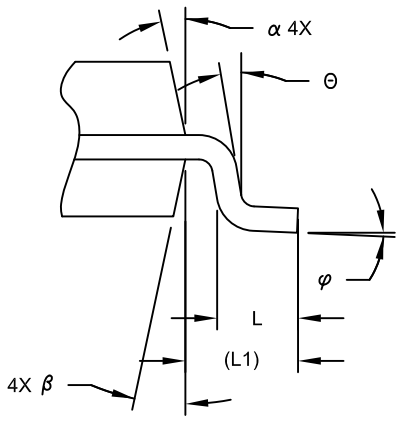


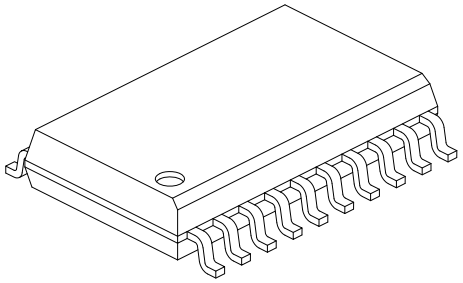
FIGURE 28-73: *Temperature Indicator Slope Normalized TO 20°C, High Range, VDD = 3.6V, LF Devices Only.*

20-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



VIEW C



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		20	
Pitch	e		1.27 BSC	
Overall Height	A	-	-	2.65
Molded Package Thickness	A2	2.05	-	-
Standoff §	A1	0.10	-	0.30
Overall Width	E		10.30 BSC	
Molded Package Width	E1		7.50 BSC	
Overall Length	D		12.80 BSC	
Chamfer (Optional)	h	0.25	-	0.75
Foot Length	L	0.40	-	1.27
Footprint	L1		1.40 REF	
Lead Angle	Θ	0°	-	-
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.20	-	0.33
Lead Width	b	0.31	-	0.51
Mold Draft Angle Top	α	5°	-	15°
Mold Draft Angle Bottom	β	5°	-	15°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic
3. Dimension D does not include mold flash, protrusions or gate burrs, which shall not exceed 0.15 mm per end. Dimension E1 does not include interlead flash or protrusion, which shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M

   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

   REF: Reference Dimension, usually without tolerance, for information purposes only.
5. Datums A & B to be determined at Datum H.

Microchip Technology Drawing No. C04-094C Sheet 2 of 2